P2001,0128



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Signature December 20, 2004

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applic. No. : 10/635,583 Confirmation No. 8569

Applicant : Heiko Hommen, et al.

Filed : August 6, 2003

Title : Method for Exposing at Least One or at Least

Two Semiconductors Wafers

Group Art Unit: 1756

Examiner : Christopher G. Young

Docket No. : P2001,0128

Customer No. : 24131

AMENDMENT

Mail Stop Amendment

Hon. Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

Sir:

Responsive to the Office Action dated February 9, 2004, kindly amend the above-identified application as follows:

Amendments to the Claims begin on page 2 of this paper.

Remarks/Arguments begin on page 10 of this paper.